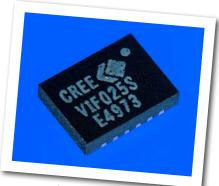


# **CGHV1F025S** 25 W, DC - 15 GHz, 40V, GaN HEMT

Cree's CGHV1F025S is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities. The device can be deployed for L, S, C, X and Ku-Band amplifier applications. The datasheet specifications are based on a X-Band (8.9 - 9.6 GHz) amplifier. The CGHV1F025S operates on a 40 volt rail circuit while housed in a 3mm x 4mm, surface mount, dual-flat-no-lead (DFN) package. Under reduced power, the transistor can operate below 40V to as low as 20V V<sub>DD</sub> maintaining high gain and efficiency.



Package Type: 3x4 DFN PN: CGHV1F025S

#### Typical Performance 8.9 - 9.6 GHz ( $T_c = 25^{\circ}c$ ), 40 V

Parameter	8.9 GHz	9.2 GHz	9.4 GHz	9.6 GHz	Units
Output Power @ $P_{IN} = 37 \text{ dBm}$	24	29	27	25	W
Drain Efficiency @ $P_{IN} = 37 \text{ dBm}$	43.5	48.5	48	46	%
Gain @ $P_{IN} = 0 \text{ dBm}$	10.7	11.6	11.3	11.1	dB

#### Note:

Measured in the CGHV1F025S-TB1 application circuit. Pulsed 100  $\mu s$  10% duty.

#### **Features**

- Up to 15 GHz Operation
- 25 W Typical Output Power
- 11 dB Gain at 9.4 GHz
- Application circuit for 8.9 9.6 GHz



# Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Notes
Drain-Source Voltage	V <sub>DSS</sub>	100	Volts	25°C
Gate-to-Source Voltage	V <sub>gs</sub>	-10, +2	Volts	25°C
Storage Temperature	T <sub>stg</sub>	-65, +150	°C	
Operating Junction Temperature	T,	225	°C	
Maximum Forward Gate Current	I <sub>gmax</sub>	4.8	mA	25°C
Maximum Drain Current <sup>1</sup>	I <sub>dmax</sub>	2	А	25°C
Soldering Temperature <sup>2</sup>	Τ <sub>s</sub>	245	°C	
Case Operating Temperature <sup>3,4</sup>	T <sub>c</sub>	-40, +150	°C	
Thermal Resistance, Junction to Case⁵	R <sub>eJC</sub>	3.4	°C/W	85°C

Note:

<sup>1</sup> Current limit for long term, reliable operation

<sup>2</sup> Refer to the Application Note on soldering at <u>www.cree.com/rf/document-library</u>

<sup>3</sup> Simulated at  $P_{DISS} = 2.4 \text{ W}$ 

 ${}^{4}T_{c}$  = Case temperature for the device. It refers to the temperature at the ground tab underneath the package. The PCB will add additional thermal resistance.

<sup>5</sup>Pulsed (100  $\mu$ s, 10% Duty). Rth for Cree's reference design using a 10 mil Rogers 5880 PCB with 31 (Ø13 mil) Vias would be 3.6 °C/W. For CW operation, the Rth numbers increase to 5°C/W for just the device, and 7.3 °C/W including the board.

# Electrical Characteristics ( $T_c = 25^{\circ}C$ ) - 40 V Typical

					-	
Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics <sup>1</sup>						
Gate Threshold Voltage	$V_{\rm GS(th)}$	-3.8	-3.0	-2.3	V <sub>DC</sub>	$V_{_{\rm DS}}$ = 10 V, $I_{_{\rm D}}$ = 4.8 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V <sub>DC</sub>	$V_{_{\rm DS}}$ = 40 V, $I_{_{\rm D}}$ = 240 mA
Saturated Drain Current <sup>2</sup>	I <sub>DS</sub>	3.8	-4.3	-	А	$V_{_{DS}}$ = 6.0 V, $V_{_{GS}}$ = 2.0 V
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	100	-	-	$V_{\rm DC}$	$V_{_{\rm GS}}$ = -8 V, $I_{_{\rm D}}$ = 4.8 mA
RF Characteristics <sup>3</sup> ( $T_c = 25^{\circ}C, F_0 = 0$	6.0 GHz unl	ess otherw	ise noted)			
Gain	G	-	16	-	dB	$V_{_{DD}}$ = 40 V, $I_{_{DQ}}$ = 150 mA, $P_{_{\rm IN}}$ = 0 dBm
Output Power <sup>4</sup>	P <sub>OUT</sub>	-	29	-	W	$V_{_{\rm DD}}$ = 40 V, $I_{_{\rm DQ}}$ = 150 mA, $P_{_{\rm IN}}$ = 34 dBm
Drain Efficiency <sup>4</sup>	η	-	55	-	%	$V_{_{\rm DD}}$ = 40 V, $I_{_{\rm DQ}}$ = 150 mA, $P_{_{\rm IN}}$ = 34 dBm
Output Mismatch Stress <sup>4</sup>	VSWR	-	10:1	-	Ψ	No damage at all phase angles, $V_{_{\rm DD}}$ = 40 V, $I_{_{\rm DQ}}$ = 150 mA, $P_{_{\rm OUT}}$ = 29 W
Dynamic Characteristics						
Input Capacitance <sup>5</sup>	C <sub>GS</sub>	-	5.9	-	pF	$V_{_{DS}}$ = 40 V, $V_{_{gs}}$ = -8 V, f = 1 MHz
Output Capacitance <sup>5</sup>	C <sub>DS</sub>	-	2	-	pF	$V_{_{DS}}$ = 40 V, $V_{_{gs}}$ = -8 V, f = 1 MHz
Feedback Capacitance	C <sub>GD</sub>	-	0.21	-	pF	$V_{_{DS}}$ = 40 V, $V_{_{gs}}$ = -8 V, f = 1 MHz

Notes:

2

<sup>1</sup> Measured on wafer prior to packaging

<sup>2</sup> Scaled from PCM data

- <sup>3</sup> Measured in CGHV1F025S-TB
- $^{\scriptscriptstyle 4}$  Pulsed 100  $\mu s,$  10% duty cycle
- <sup>5</sup> Includes package

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#### **Electrical Characteristics When Tested in CGHV1F025S-TB1**

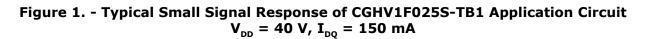
Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
RF Characteristics <sup>1</sup> ( $T_c = 25^{\circ}C, F_0 = 8.9 - 9.6$ GHz unless otherwise noted)						
Gain	G	-	11.6	-	dB	$V_{_{DD}}$ = 40 V, $I_{_{DQ}}$ = 150 mA, $P_{_{\rm IN}}$ = 0 dBm
Output Power <sup>2</sup>	P <sub>OUT</sub>	-	29	-	W	$V_{_{\rm DD}}$ = 40 V, $I_{_{\rm DQ}}$ = 150 mA, $P_{_{\rm IN}}$ = 37 dBm
Drain Efficiency <sup>2</sup>	η	-	48.5	-	%	$V_{_{\rm DD}}$ = 40 V, $I_{_{\rm DQ}}$ = 150 mA, $P_{_{\rm IN}}$ = 37 dBm
Output Mismatch Stress <sup>2</sup>	VSWR	-	10:1	-	Ψ	$V_{_{\rm DS}}$ = 40 V, $V_{_{\rm gs}}$ = -8 V, $P_{_{\rm OUT}}$ = 25 W

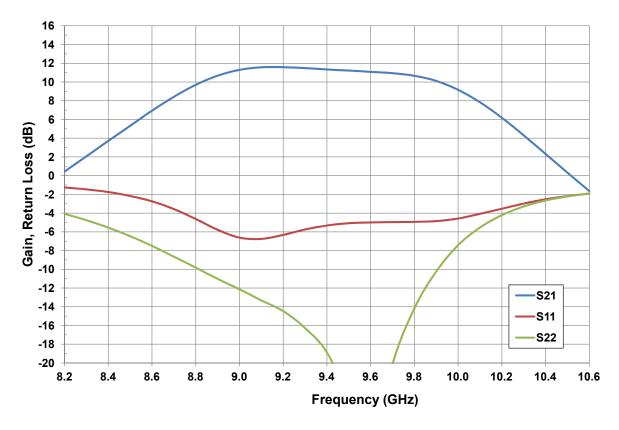
Notes:

<sup>1</sup> Measured in CGHV1F025S-TB1 Application Circuit

 $^2$  Pulsed 100 µs, 10% duty cycle

#### Typical Performance - CGHV1F025S-TB1



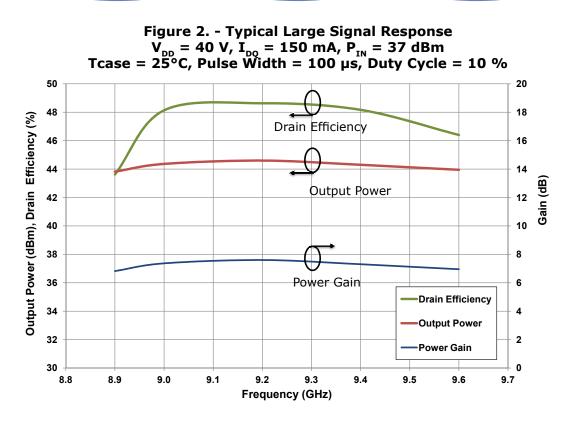


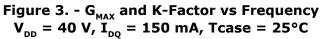
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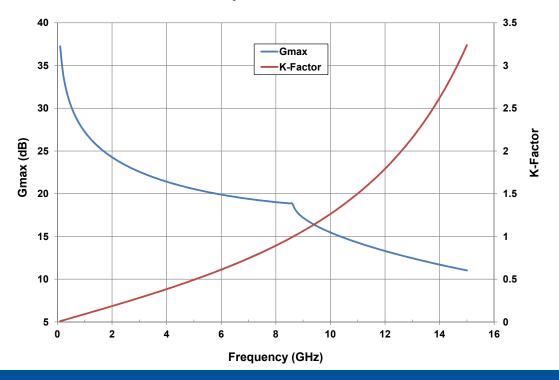
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#### Typical Performance in Application Circuit CGHV1F025S-TB1







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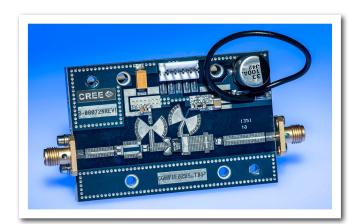


# CGHV1F025S-TB1 Application Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 100, OHM, +1/-1%, 1/16 W, 0603	1
R2	RES, 10, OHM, +1/-1%, 1/16 W, 0603	1
C1, C2	CAP, 1pF, ±0.1 pF, 0603, ATC	2
C3, C4	CAP, 1.8pF, ±0.1 pF, 0603, ATC	2
C9, C10	CAP, 0.6pF, ±0.1 pF, 0603, ATC	2
C5, C11	CAP, 10 pF, ±5%, 0603, ATC	1
C6, C12	CAP, 470 pF, 5%, 100 V, 0603, X	2
C7, C13	CAP, 33000 pF, 0805, 100V, X7R	2
C14	CAP, 1.0 UF, 100V, 10%, X7R, 1210	1
C8	CAP, 10 UF, 16V TANTALUM	1
C15	CAP, 33UF, 20%, G CASE	1
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE	2
J3	HEADER RT>PLZ .1CEN LK 5POS	1
Q1	QFN TRANSISTOR CGHV1F025S	1
W1	CABLE, 18 AWG, 4.2	1
	Rogers 5880 PCB 10 mils	1

# CGHV1F025S-TB1 Application Circuit





# Electrostatic Discharge (ESD) Classifications

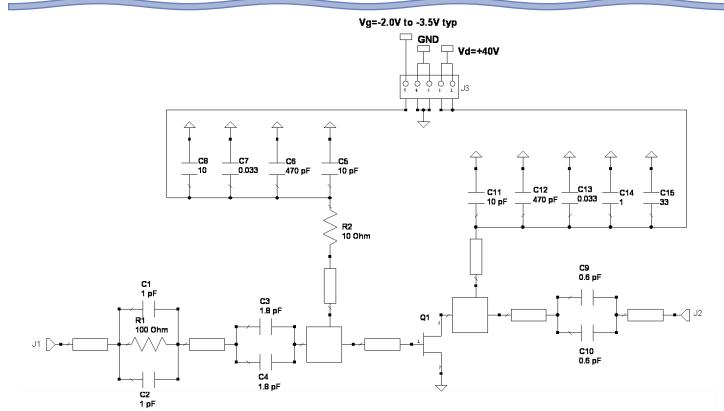
Parameter	Symbol	Class	Test Methodology
Human Body Model	НВМ	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	2 (125 V to 250 V)	JEDEC JESD22 C101-C

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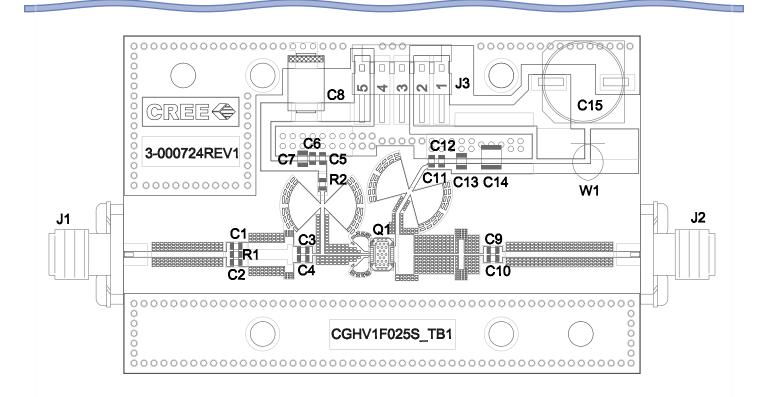
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## CGHV1F025S-TB1 Application Circuit Schematic



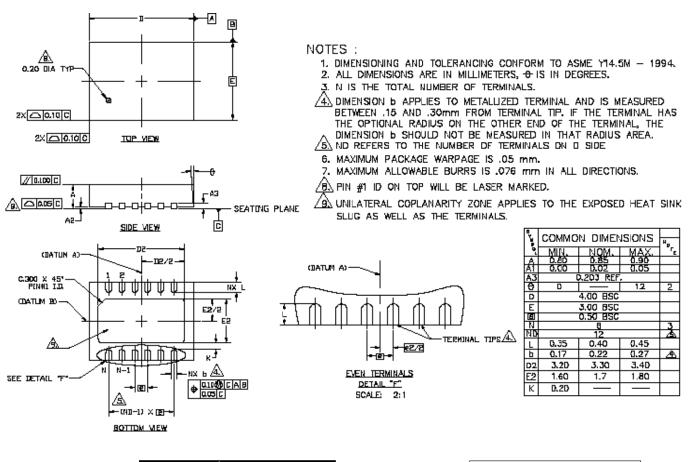
# CGHV1F025S-TB1 Application Circuit Outline



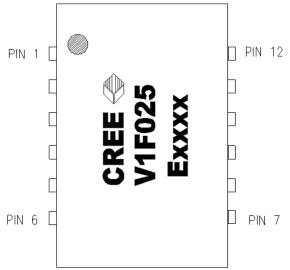
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## Product Dimensions CGHV1F025S (Package 3 x 4 DFN)



Pin	Input/Output
1	GND
2	RF IN
3	RF IN
4	RF IN
5	RF IN
6	GND
7	GND
8	RF OUT
9	RF OUT
10	RF OUT
11	RF OUT
12	GND

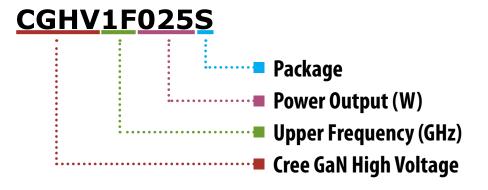


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#### Part Number System



Parameter	Value	Units
Upper Frequency <sup>1</sup>	15.0	GHz
Power Output	25	W
Package	Surface Mount	-



**Note**<sup>1</sup>: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
E	4
F	5
G	6
Н	7
J	8
К	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

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CGHV1F025S Rev 0.2 - Preliminary



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